

MOSFET PG-T0220-3

StrongIRFET™2 Power-Transistor, 60 V

Features

- Optimized for wide range of applications
- N-channel, normal level
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

Product validation

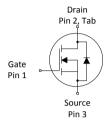
Qualified according to JEDEC Standard

Table 1 **Kev Performance Parameters**

Parameter	Value	Unit						
$V_{ m DS}$	60	V						
$R_{\mathrm{DS(on),max}}$	1.9	mΩ						
I_{D}	190	А						
$Q_{ m oss}$	108	nC						
Q _G (0V10V)	108	nC						











Type/Ordering Code	Package	Marking	Related Links
IPP019N06NF2S	PG-TO220-3	019N06NS	-

Public

StrongIRFET™2 Power-Transistor, 60 V IPP019N06NF2S



Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	5
Electrical characteristics diagrams	7
Package Outlines	11
Revision History	12
Trademarks	12
Disclaimer	12

StronglRFET™2 Power-Transistor, 60 V IPP019N06NF2S



1 Maximum ratings

at T_{Δ} =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note/Test Condition
raiailletei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Continuous drain current ¹⁾	I _D	-	-	190 146 33	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	760	А	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	349	mJ	$I_{\rm D}$ =100 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	P_{tot}	-	-	231 3.8	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾
Operating and storage temperature	$T_{\rm j}$, $T_{\rm stg}$	-55	-	175	°C	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

StrongIRFET™2 Power-Transistor, 60 V IPP019N06NF2S



2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Nieto/Tost Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Thermal resistance, junction - case	R_{thJC}	-	-	0.65	°C/W	-
Thermal resistance, junction - ambient, 6 cm ² cooling area ⁵⁾	R_{thJA}	-	-	40	°C/W	-
Thermal resistance, junction - ambient, minimal footprint	R_{thJA}	-	-	62	°C/W	-

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

StronglRFET™2 Power-Transistor, 60 V IPP019N06NF2S



3 Electrical characteristics

at T_i =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Syllibol	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	2.1	2.8	3.3	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 129 \mu{\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.5 10	1 100	μΑ	$V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =60 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V
Drain-source on-state resistance ⁶⁾	$R_{\mathrm{DS(on)}}$	-	1.7 2.1	1.9 2.9	mΩ	V_{GS} =10 V, I_{D} =100 A V_{GS} =6 V, I_{D} =50 A
Gate resistance	R_{G}	-	2.7	-	Ω	-
Transconductance ⁷⁾	g_{fs}	110	-	-	S	$ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 100 \text{ A}$

⁶⁾ R_{DS(on)} is specified at a distance of 1.8 mm distance to the package body; mounting at a larger distance increases the overallpackage resistance of approximately 0.04 mOhm/mm per leg.

Table 5 Dynamic characteristics

Darameter	Cymphol	Values			l lm!t	Note / Test Condition
Parameter	Symbol Min. Typ.		Мах.	Unit	Note/ Test Condition	
Input capacitance	C _{iss}	-	7300	-	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	1550	-	pF	V _{GS} =0 V, V _{DS} =30 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C _{rss}	-	63	-	pF	$V_{\rm GS}$ =0 V, $V_{\rm DS}$ =30 V, f =1 MHz
Turn-on delay time	$t_{d(on)}$	-	22	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	31	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	48	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	17	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailietei	Syllibot	Min.	Тур.	Мах.	Offic	Note/ Test Condition
Gate to source charge	$Q_{ m gs}$	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge at threshold	$Q_{\mathrm{g(th)}}$	-	20	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	20	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V

⁷⁾ Defined by design. Not subject to production test.

StrongIRFET™2 Power-Transistor, 60 V IPP019N06NF2S



Table 6 Gate charge characteristics 8)

Parameter	Symbol	Values			Unit	Note/ Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.		Note/ Test Condition
Switching charge	Q_{sw}	-	33	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total ⁹⁾	$Q_{ m g}$	-	108	162	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	$V_{ m plateau}$	-	4.5	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	100	-	nC	$V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V
Output charge	$Q_{\rm oss}$	-	108	-	nC	$V_{\rm DS}$ =30 V, $V_{\rm GS}$ =0 V

⁸⁾ See "Gate charge waveforms" for parameter definition

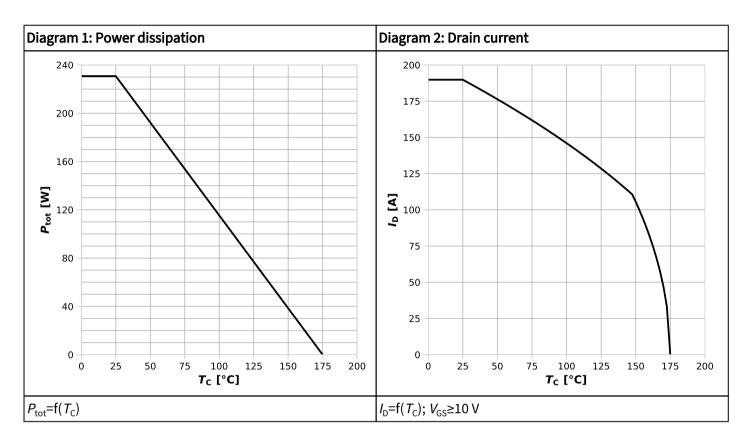
Table 7 Reverse diode

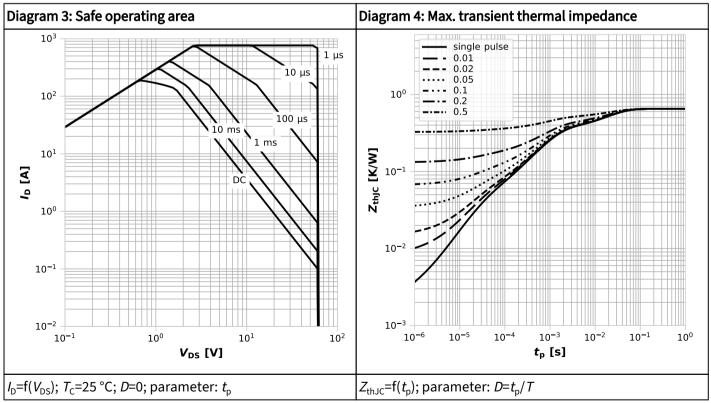
Parameter	Symbol	Values			Linit	Note/ Test Condition
raiailletei	Symbol	Min.	Тур.	Мах.	Unit	Note/ Test Condition
Diode continuous forward current	I_{S}	-	-	153	А	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	760	А	<i>T</i> _C =25 °C
Diode forward voltage	$V_{\rm SD}$	-	0.92	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =100 A, $T_{\rm j}$ =25 °C
Reverse recovery time	$t_{\rm rr}$	-	46	-	ns	V_R =30 V, I_F =100 A, d i_F /d t =100 A/ μ s
Reverse recovery charge	$Q_{\rm rr}$	-	53	-	nC	V_{R} =30 V, I_{F} =100 A, d i_{F} /d t =100 A/ μ s
Reverse recovery time	t _{rr}	-	33	-	ns	V_{R} =30 V, I_{F} =100 A, d i_{F} /d t =500 A/ μ s
Reverse recovery charge	$Q_{\rm rr}$	-	164	-	nC	$V_{\rm R}$ =30 V, $I_{\rm F}$ =100 A, d $i_{\rm F}$ /d t =500 A/ μ s

⁹⁾ Defined by design. Not subject to production test.

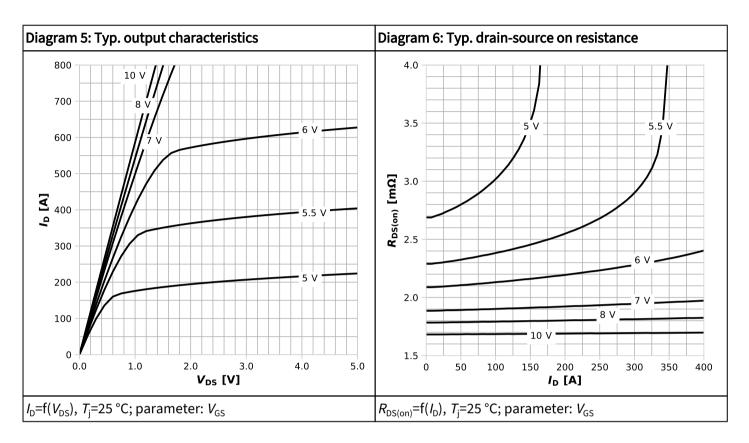


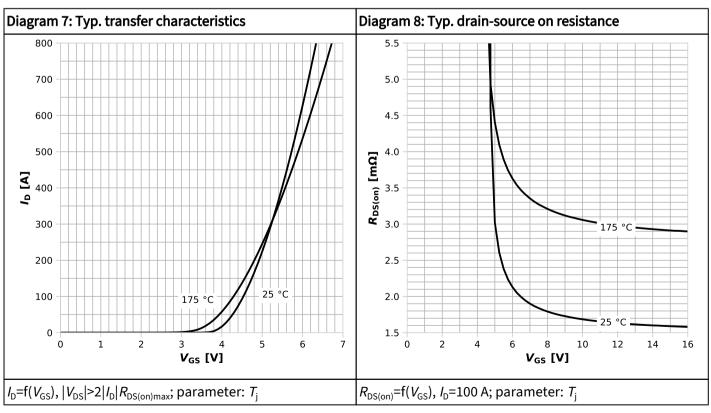
4 Electrical characteristics diagrams



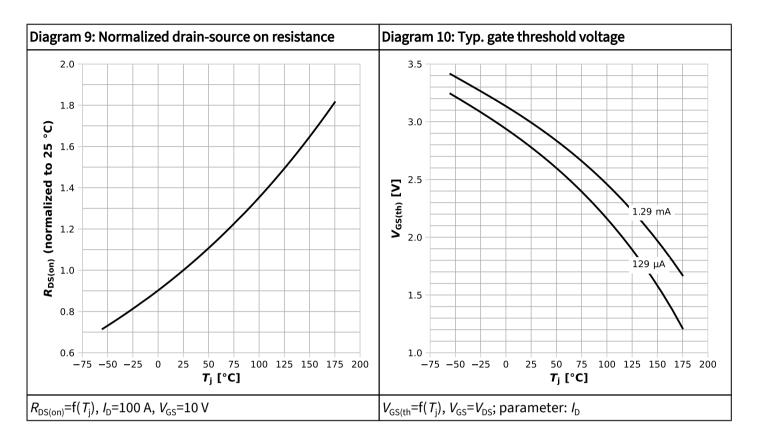


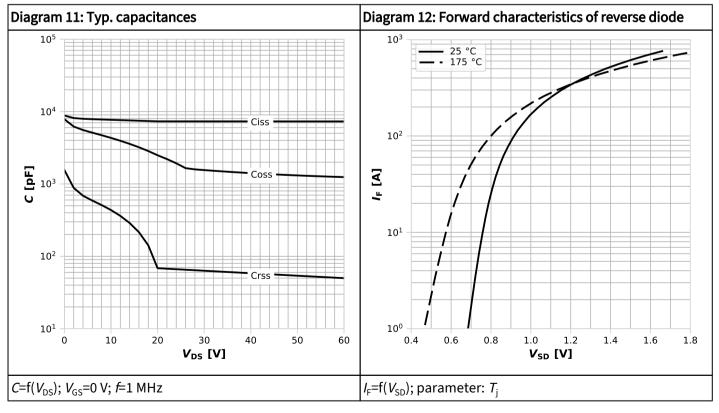




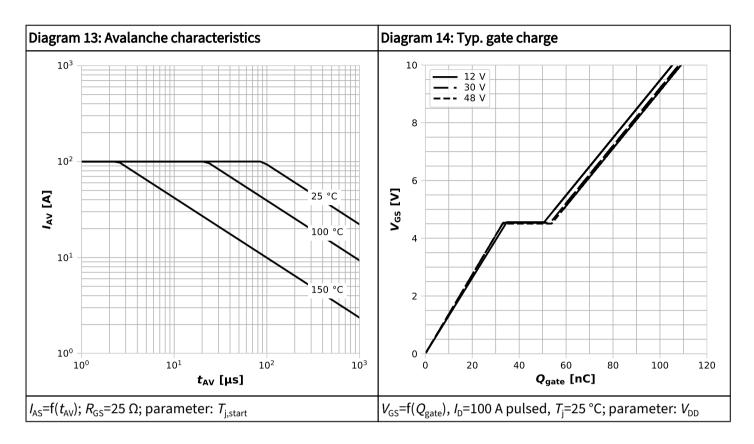


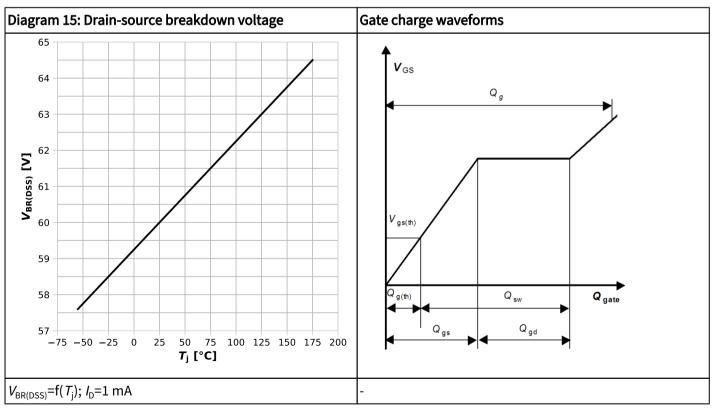














5 Package Outlines

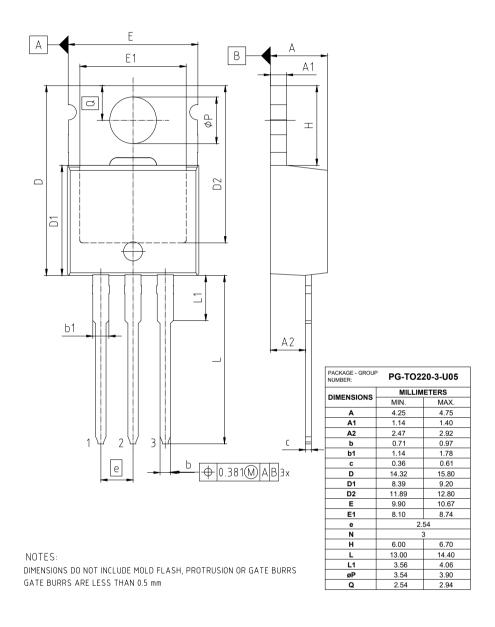


Figure 1 Outline PG-TO220-3, dimensions in mm

StronglRFET™2 Power-Transistor, 60 V IPP019N06NF2S



Revision History

IPP019N06NF2S

Revision 2024-10-14, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2022-02-14	Release of final version
2.1	2022-05-19	Updated diagram 12 title
2.2	2024-10-14	Added trr and Qrr at diF/dt=100 A/μs

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